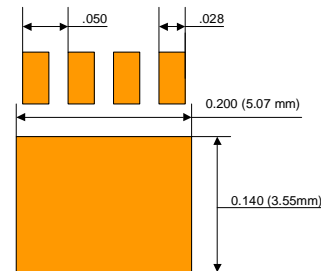
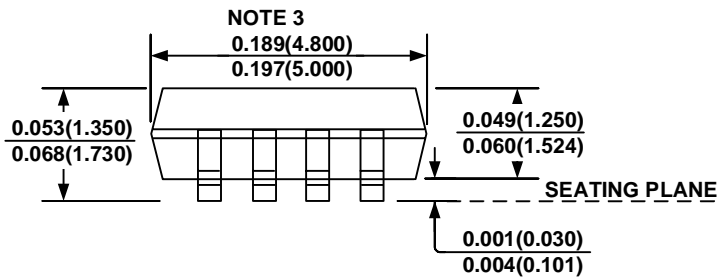
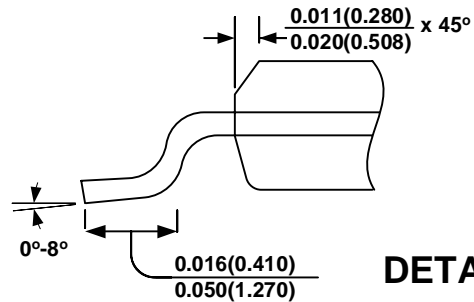


SEE DETAIL "A"



Land Pattern

NOTE:

- 1) Control dimension is in inches. Dimension in bracket is millimeters.
- 2) Exposed Pad Option (N-Package) ; 2.31mm -2.79mm x 2.79mm - 3.81mm.
Recommend Solder Board Area: 2.80mm x 3.82mm = 10.7mm² (16.6 mil²)
- 3) The length of the package does not include mold flash. Mold flash shall not exceed 0.006in. (0.15mm) per side.
With the mold flash included, over-all length of the package is 0.2087in. (5.3mm) max.
- 4) The width of the package does not include mold flash. Mold flash shall not exceed 0.10in. (0.25mm) per side.
With the mold flash included, over-all width of the package is 0.177in. (4.5mm) max.